# ADVANCED POWER TECHNOLOGY®

## APT10045JLL

**1000V 21A 0.450**Ω

## POWER MOS 7™

Power MOS  $7^{\text{TM}}$  is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS  $7^{\text{TM}}$  by significantly lowering  $R_{\text{DS(ON)}}$  and  $Q_g$ . Power MOS  $7^{\text{TM}}$  combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.



- Increased Power Dissipation
- Lower Miller Capacitance
- Easier To Drive
- Lower Gate Charge, Qg
- Popular SOT-227 Package





#### **MAXIMUM RATINGS**

All Ratings:  $T_C = 25^{\circ}$ C unless otherwise specified.

| Symbol           | Parameter   | APT0045JLL | UNIT  |  |
|------------------|---|------------|-------|--|
| V <sub>DSS</sub> | Drain-Source Voltage                              | 1000       | Volts |  |
| I <sub>D</sub>   | Continuous Drain Current @ T <sub>C</sub> = 25°C  | 21         | Amps  |  |
| I <sub>DM</sub>  | Pulsed Drain Current ①                            | 84         |       |  |
| V <sub>GS</sub>  | Gate-Source Voltage Continuous                    | ±30        | Volts |  |
| V <sub>GSM</sub> | Gate-Source Voltage Transient                     | ±40        |       |  |
| P <sub>D</sub>   | Total Power Dissipation @ T <sub>C</sub> = 25°C   | 460        | Watts |  |
|                  | Linear Derating Factor                            | 3.68       | W/°C  |  |
| $T_J, T_STG$     | Operating and Storage Junction Temperature Range  | -55 to 150 | °C    |  |
| T <sub>L</sub>   | Lead Temperature: 0.063" from Case for 10 Sec.    | 300        |       |  |
| I <sub>AR</sub>  | Avalanche Current (Repetitive and Non-Repetitive) | 21         | Amps  |  |
| E <sub>AR</sub>  | Repetitive Avalanche Energy ①                     | 50         | m     |  |
| E <sub>AS</sub>  | Single Pulse Avalanche Energy <sup>(4)</sup>      | 2500       | mJ    |  |

#### STATIC ELECTRICAL CHARACTERISTICS

|                     |   | 100  |     |       |       |
|---------------------|---|------|-----|-------|-------|
| Symbol              | Characteristic / Test Conditions  | MIN  | TYP | MAX   | UNIT  |
| BV <sub>DSS</sub>   | Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA)               | 1000 |     |       | Volts |
| I <sub>D(on)</sub>  | On State Drain Current ② $(V_{DS} > I_{D(on)} \times R_{DS(on)} Max, V_{GS} = 10V)$         | 21   |     |       | Amps  |
| R <sub>DS(on)</sub> | Drain-Source On-State Resistance ② (V <sub>GS</sub> = 10V, 0.5 I <sub>D[Cont.]</sub> )      |      |     | 0.450 | Ohms  |
| I <sub>DSS</sub>    | Zero Gate Voltage Drain Current (V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0V) |      |     | 100   | μΑ    |
|                     | Zero Gate Voltage Drain Current $(V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_{C} = 125$ °C)       |      |     | 500   |       |
| I <sub>GSS</sub>    | Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$                               |      |     | ±100  | nA    |
| V <sub>GS(th)</sub> | Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 2.5 \text{mA})$                           | 3    |     | 5     | Volts |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

USA

#### **DYNAMIC CHARACTERISTICS**

| Δ | P٦ | Г1 | n | U | 45 | . 1 | ı | ı |
|---|----|----|---|---|----|-----|---|---|
|   |    |    |   |   |    |     |   |   |

| Symbol              | Characteristic                 | Test Conditions                      | MIN | TYP  | MAX | UNIT |
|---------------------|--------------------------------|--------------------------------------|-----|------|-----|------|
| C <sub>iss</sub>    | Input Capacitance              | V <sub>GS</sub> = 0V                 |     | 4335 |     |      |
| C <sub>oss</sub>    | Output Capacitance             | V <sub>DS</sub> = 25V                |     | 720  |     | pF   |
| C <sub>rss</sub>    | Reverse Transfer Capacitance   | f = 1 MHz                            |     | 129  |     |      |
| $Q_g$               | Total Gate Charge <sup>③</sup> | V <sub>GS</sub> = 10V                |     | 159  |     |      |
| Q <sub>gs</sub>     | Gate-Source Charge             | $V_{DD} = 0.5 V_{DSS}$               |     | 19   |     | nC   |
| $Q_{gd}$            | Gate-Drain ("Miller") Charge   | $I_{D} = I_{D[Cont.]} @ 25^{\circ}C$ |     | 101  |     |      |
| t <sub>d(on)</sub>  | Turn-on Delay Time             | V <sub>GS</sub> = 15V                |     | 10   |     |      |
| t <sub>r</sub>      | Rise Time                      | $V_{DD} = 0.5 V_{DSS}$               |     | 7    |     | ns   |
| t <sub>d(off)</sub> | Turn-off Delay Time            | $I_{D} = I_{D[Cont.]} @ 25^{\circ}C$ |     | 32   |     | 113  |
| t <sub>f</sub>      | Fall Time                      | $R_{G} = 0.6\Omega$                  |     | 8    |     |      |

#### **SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS**

| Symbol            | Characteristic / Test Conditions   | MIN | TYP  | MAX | UNIT  |
|-------------------|--|-----|------|-----|-------|
| I <sub>s</sub>    | Continuous Source Current (Body Diode)   |     |      | 21  | Amna  |
| I <sub>SM</sub>   | Pulsed Source Current ① (Body Diode)   |     |      | 84  | Amps  |
| V <sub>SD</sub>   | Diode Forward Voltage ② (V <sub>GS</sub> = 0V, I <sub>S</sub> = -I <sub>D[Cont.]</sub> ) |     |      | 1.3 | Volts |
| t rr              | Reverse Recovery Time $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$                      |     | 560  |     | ns    |
| Q <sub>rr</sub>   | Reverse Recovery Charge $(I_S = -I_{D[Cont.]}, dI_S/dt = 100A/\mu s)$                    |     | 20.7 |     | μC    |
| dv/ <sub>dt</sub> | Peak Diode Recovery dv/ <sub>dt</sub> (5)  |     |      | 10  | V/ns  |

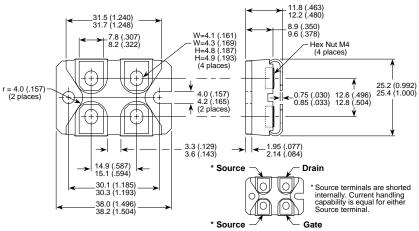
#### THERMAL CHARACTERISTICS

| Symbol        | Characteristic      | MIN | TYP | MAX  | UNIT |
|---------------|---------------------|-----|-----|------|------|
| $R_{	hetaJC}$ | Junction to Case    |     |     | 0.27 | °C/W |
| $R_{	hetaJA}$ | Junction to Ambient |     |     | 40   | C/VV |

① Repetitive Rating: Pulse width limited by maximum junction temperature.

APT Reserves the right to change, without notice, the specifications and information contained herein.

### SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

<sup>2</sup> Pulse Test: Pulse width < 380 µs, Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

 $<sup>\</sup>textcircled{4}$  Starting T<sub>j</sub> = +25°C, L = 11.34mH, R<sub>G</sub> = 25 $\Omega$ , Peak I<sub>L</sub> = 21A

<sup>(5)</sup>  $dv/_{dt}$  numbers reflect the limitations of the test circuit rather than the device itself.  $v_{s} \le -v_{D[Cont.]}$   $v_{t} \le 700 \text{A/µs}$   $v_{t} \le v_{DSS}$   $v_{t} \le 150 \text{°C}$